



Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
USPTO Use Only

EFS ID: 63521

Application ID: 10749096



Title of Invention:

MULTI-LAYER INTEGRATED  
SEMICONDUCTOR STRUCTURE  
HAVING AN ELECTRICAL  
SHIELDING PORTION

First Named Inventor: Rafael Reif

Domestic/Foreign Application: Domestic Application

Filing Date: 2003-12-30

Effective Receipt Date: 2004-06-29

Submission Type: Information Disclosure  
Statement

Filing Type:

Confirmation number: 3177

Attorney Docket Number: MIT-136DUS


Total Fees Authorized:

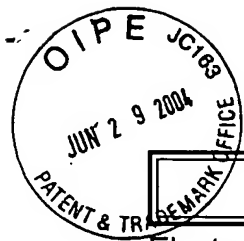
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**TRANSMITTAL**

Electronic Version v1.1

Stylesheet Version v1.1.0

<b>Title of Invention</b>	<b>MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE HAVING AN ELECTRICAL SHIELDING PORTION</b>									
Application Number: 10/749096 										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Christopher S Daly Registered Number: 37,303</td><td>/csd/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Christopher S Daly Registered Number: 37,303	/csd/	Attorney		
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<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>MIT-136DUS-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	MIT-136DUS-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	MIT-136DUS-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
<b>Comments</b>										



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of  
Invention

MULTI-LAYER INTEGRATED SEMICONDUCTOR  
STRUCTURE HAVING AN ELECTRICAL SHIELDING  
PORTION

Application Number: 10/749096



Confirmation Number: 3177

First Named Applicant: Rafael Reif

Attorney Docket Number: MIT-136DUS

Art Unit: 3745

Search string: ( 4313126 or 4402761 or 4456888 or 4599704  
or 4986861 or 5156997 or 5206186 or 5445994  
or 5821138 or 5923087 or 6441478 ).pn.

### US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	4313126	1982-01-26	Krumm et al.			
	2	4402761	1983-09-06	Feist			
	3	4456888	1984-01-26	Ayasli			
	4	4599704	1986-07-08	Mazin			
	5	4986861	1991-01-22	Nishida et al.			
	6	5156997	1992-10-20	Kumar et al.			
	7	5206186	1993-04-27	Neugebauer et al.			
	8	5445994	1995-08-29	Gilton			
	9	5821138	1998-10-13	Yamazaki et al.			
	10	5923087	1999-07-13	Suzuki et al.			
	11	6441478	2002-08-27	Park			

Signature

Examiner Name	Date